



Serial No. 09/225,198

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C., 20231, on:

Date - November 18, 2002By: Corina M. Tan

DOCKET No.: 59501-8016.US01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Cheyen et al.

SERIAL No.: 09/225,198

FILED: 01/05/99

FOR: SOFTWARE-BASED ARCHITECTURE FOR
COMMUNICATION AND COOPERATION
AMONG DISTRIBUTED ELECTRONICS
AGENTS

EXAMINER: Bullock Jr., L.

ART UNIT: 2151

RECEIVED

SEP 17 2004

Technology Center 2100

DECLARATION UNDER 37 C.F.R. §1.132

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

I, Adam J Cheyer, declare and affirm as follows:

1. I am a co-inventor, along with David L. Martin, of the subject matter described and claimed in U.S. Patent Application Serial No. 09/225,198, filed January 05, 1999, entitled SOFTWARE-BASED ARCHITECTURE FOR COMMUNICATION AND COOPERATION AMONG DISTRIBUTED ELECTRONICS AGENTS.
2. I am co-author of an article published in March, 1998, entitled "Building Distributed Software Systems with the Open Agent Architecture." The article included as co-authors, David L. Martin and Douglas B. Moran. Thus, the article was published less than one year from the filing date of the instant application.
3. I and David L. Martin are the inventors of the subject matter, which is claimed in claims 1-

Serial No. 09/225,198

86 in the instant application.

4. Douglas B. Moran is not a co-inventor of the subject matter described in the subject matter disclosed and claimed in the instant application.

I declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Respectfully submitted,

11/15/02
Date

Adam J. Cheyer
Adam J. Cheyer



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2. I am co-author of an article published in March, 1998, entitled "Building Distributed Software Systems with the Open Agent Architecture." The article included as co-authors, Adam J. Cheyer and Douglas B. Moran. Thus, the article was published less than one year from the filing date of the instant application.

3. I and Adam J. Cheyer are the inventors of the subject matter, which is claimed in claims 1-

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Respectfully submitted,

11/14/2002
Date

David L. Martin
David L. Martin